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VS-GB100DA60UP

Vishay Semiconductors

Insulated Gate Bipolar Transistor (Warp 2 Speed IGBT), 100 A



SOT-227

PRODUCT SUMMARY							
V _{CES}	600 V						
I _C DC	100 A at 61 °C						
V _{CE(on)} typical at 100 A, 25 °C	2.4 V						
I _F DC	100 A at 85 °C						
Package	SOT-227						
Circuit	Single Switch Diode						

FEATURES

- NPT warp 2 speed IGBT technology with positive temperature coefficient
- Square RBSOA
- HEXFRED[®] antiparallel diodes with ultrasoft reverse recovery
- Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Higher switching frequency up to 150 kHz
- Lower conduction losses and switching losses
- Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Collector to emitter voltage	V _{CES}		600	V			
Continuous collector current		T _C = 25 °C	125				
Continuous collector current	Ι _C	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	85				
Pulsed collector current	I _{CM}		300				
Clamped inductive load current	I _{LM}		300	A			
Diode continuous forward current	I _F	T _C = 25 °C	160				
Diode continuous forward current		T _C = 80 °C	105				
Peak diode forward current	I _{FM}		200				
Gate to emitter voltage	V _{GE}		± 20	V			
Dever dissipation ICPT	6	T _C = 25 °C	447				
Power dissipation, IGBT	PD	T _C = 80 °C	250	\A/			
		T _C = 25 °C	313	W			
Power dissipation, diode	P _D	T _C = 80 °C	175				
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V			



ROHS COMPLIANT

Revision: 13-Sep-13

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ELECTRICAL SPECIFICATIONS ($T_J = 25$ °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$	600	-	-			
Collector to omitter voltage	V	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	-	2.4	2.8	v		
Collector to emitter voltage	V _{CE(on)}	V_{GE} = 15 V, I_C = 100 A, T_J = 125 $^\circ C$	-	3	3.4			
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$	3	3.9	5			
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	V_{CE} = V_{GE} , I_C = 1 mA (25 °C to 125 °C)	-	-10	-	mV/°C		
Collector to emitter leakage current		$V_{GE} = 0 V, V_{CE} = 600 V$	-	7	100	μA		
Collector to emitter leakage current	I _{CES}	V_{GE} = 0 V, V_{CE} = 600 V, T_J = 150 $^\circ C$	-	4	10	mA		
	V _{FM}	$I_{C} = 100 \text{ A}, V_{GE} = 0 \text{ V}$	-	1.6	2.1	v		
Forward voltage drop		I_{C} = 100 A, V_{GE} = 0 V, T_{J} = 125 °C	-	1.7	2	v		
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 200	nA		

PARAMETER	SYMBOL	TEST CONDIT	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg		-	460	690		
Gate to emitter charge (turn-on)	Q _{ge}	$I_{\rm C}$ = 100 A, $V_{\rm CC}$ = 480 V,	-	160	250	nC	
Gate to collector charge (turn-on)	Q _{gc}		-	70	130		
Turn-on switching loss	E _{on}	I _C = 100 A, V _{CC} = 360 V,	L = 100 A V = = 260 V		0.36	-	
Turn-off switching loss	E _{off}	$V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$		-	1.42	-	
Total switching loss	E _{tot}	L = 500 µH, T _J = 25 °C		-	1.78	-	- mJ
Turn-on switching loss	E _{on}		Franklands	-	0.52	-	
Turn-off switching loss	E _{off}		Energy losses include tail and diode recovery (see fig. 18)	-	1.6	-	
Total switching loss	E _{tot}	I _C = 100 A, V _{CC} = 360 V,		-	2.12	-	
Turn-on delay time	t _{d(on)}	$V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$		-	264	-	
Rise time	t _r	L = 500 µH, T _J = 125 °C		-	54	-	
Turn-off delay time	t _{d(off)}			-	257	-	ns
Fall time	t _f			-	80	-	
Reverse bias safe operating area	RBSOA	$\begin{split} T_J &= 150 \ ^\circ C, \ I_C &= 300 \ A, \\ V_{GE} &= 15 \ V \ to \ 0 \ V, \ V_{CC} &= \\ V_P &= 600 \ V, \ L &= 500 \ \mu H \end{split}$	5		Fullsquare		
Diode reverse recovery time	t _{rr}			-	95	120	ns
Diode peak reverse current	l _{rr}	$I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/1000 \text{ A}$	′μs, V _R = 200 V	-	10	13	А
Diode recovery charge	Q _{rr}		-	480	780	nC	
Diode reverse recovery time	t _{rr}			-	144	185	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _B = 200 V, T _I = 125 °C		-	16	19	А
Diode recovery charge	Q _{rr}	· · · · · · · · · · · · · · · · · · ·	-	1136	1758	nC	

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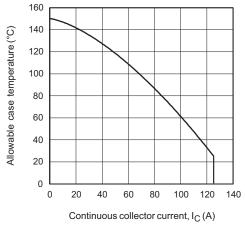


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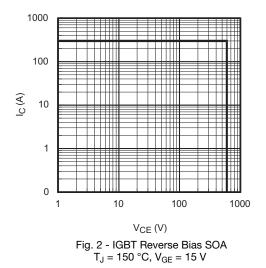
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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL		MIN.	TYP.	MAX.	UNITS	
Junction and storage temperature range	T _J , T _{Stg}		-40	-	150	°C	
Junction to case	P		-	-	0.28		
Diode	R _{thJC}		-	-	0.4	°C/W	
Case to heatsink	R _{thCS}	Flat, greased surface	-	0.05	-		
Weight			-	30	-	g	
Mounting torque			-	-	1.3	Nm	
Case style	SOT-227						







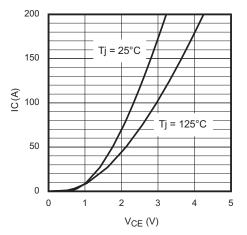
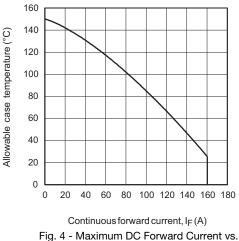


Fig. 3 - Typical IGBT Collector Current Characteristics



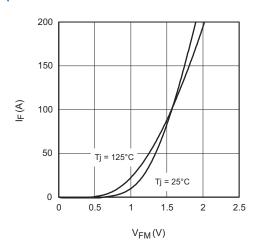
Case Temperature

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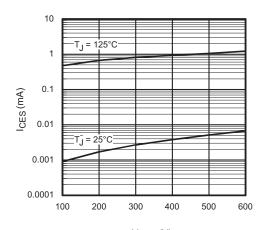


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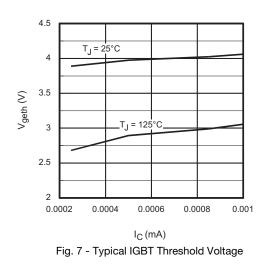
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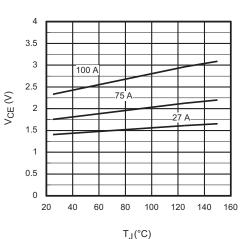
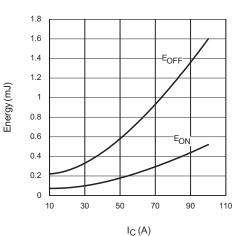
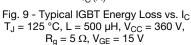
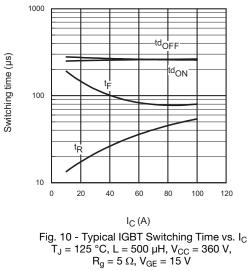


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature, $V_{GE} = 15 V$







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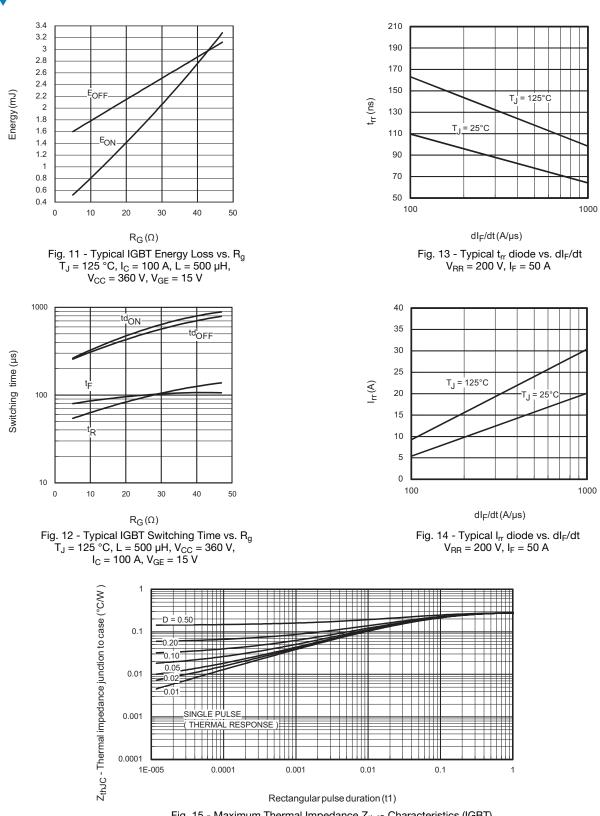


Fig. 15 - Maximum Thermal Impedance Z_{thJC} Characteristics (IGBT)



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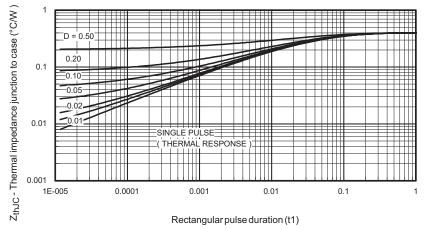
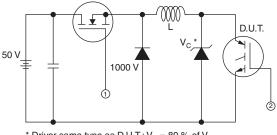
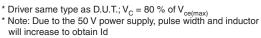
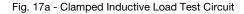


Fig. 16 - Maximum Thermal Impedance Z_{thJC} Characteristics (diode)







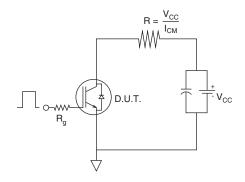


Fig. 17b - Pulsed Collector Current Test Circuit

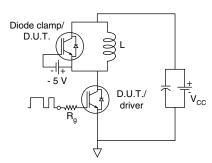


Fig. 18a - Switching Loss Test Circuit



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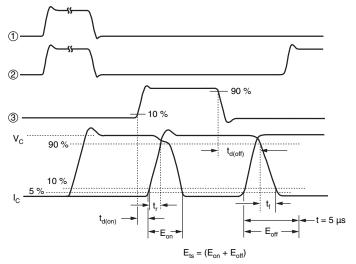
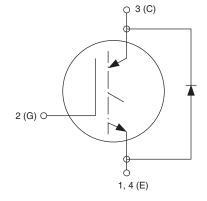


Fig. 18b - Switching Loss Waveforms Test Circuit

ORDERING INFORMATION TABLE

Device code	VS-	G	В	100	D	Α	60	U	Ρ	
		2	3	4	5	6	7	8	9	I
	1 -	Visl	nay Sen	niconduo	ctors pro	oduct				
	2 - Insulated Gate Bipolar Transistor (IGBT)									
	3 -	- B = IGBT Generation 5								
	4 -	- Current rating (100 = 100 A)								
	5 -	5 - Circuit configuration (D = Single switch with antiparallel diode)							ode)	
	6 -	- Package indicator (A = SOT-227)								
	7 -	Voltage rating (60 = 600 V)								
	8 -	Speed/type (U = Ultrafast IGBT)								
	9 -	Tota	Totally lead (Pb)-free							

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?95036					
Packaging information	www.vishay.com/doc?95037				
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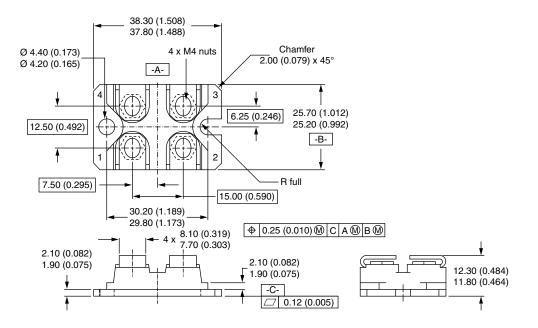


Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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